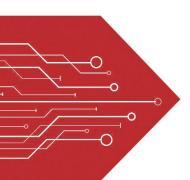
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SOD-523



BAT46X SCHOTTKY BARRIER DIODE

FEATURES

- High breakdown voltage
- Low turn-on voltage
- Guard ring construction for transient protection

Maximum Ratings @Ta=25℃

Parameter	Symbol	Limit	Unit
Peak repetitive peak reverse voltage		100	V
Working peak reverse voltage	V_{RWM}		
Forward continuous current	I _F	150	mA
Repetitive peak forward current (Note 1) @ tp < 1.0s, Duty Cycle < 50%	I _{FRM}	350	mA
Non-repetitive Peak Forward surge current @ t = 8.3ms	I _{FSM}	750	mA
Power dissipation	P _D	150	mW
Thermal resistance junction to ambient air	$R_{\theta JA}$	667	°C/W
Operating Junction Temperature Range	Tj	-40 ~ +125	$^{\circ}$
Storage Temperature Range	T _{STG}	-55 ~ +150	°C

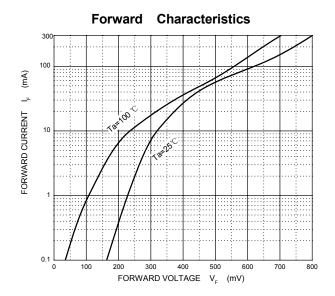
ELECTRICAL CHARACTERISTICS (Ta=25℃ unless otherwise specified)

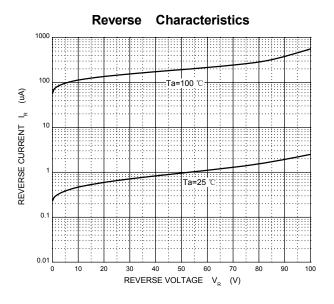
Parameter	Symbol	Test Conditions	Min	Тур	Max	Unit
Reverse breakdown voltage(Note 2)	V_R	I _R = 100μA	100			V
Reverse voltage leakage current	I _R	V _{R1} =1.5V			0.3	μΑ
		V _{R2} =10V			0.5	
		V _{R3} =50V			1	
		V _{R4} =75V			2	
	V _F	I _{F1} =0.1mA			0.25	V
Forward voltage(Note 2)		I _{F2} =10mA			0.45	
		I _{F3} =250mA			1	
Diode capacitance	_	V _R =0, f=1MHz		20		_
	C _T	V _R =1V, f=1MHz		12		pF

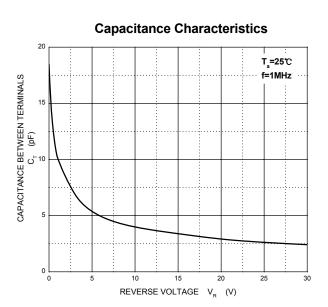
Notes: 1. Part mounted on FR-4 board with recommended pad layout.

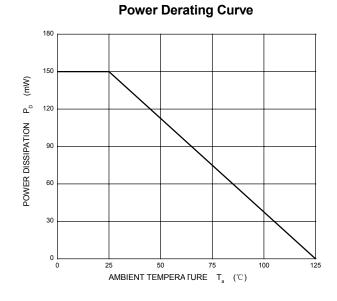
2. Short duration pulse test used to minimize self-heating effect.





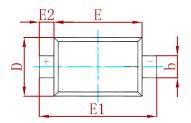


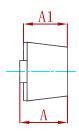


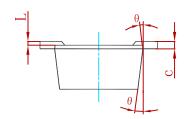




PACKAGE MECHANICAL DATA

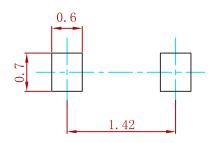






Symbol	Dimensions In Millimeters		Dimensions In Inches		
Зушьог	Min	Max	Min	Max	
Α	0.510	0.770	0.020	0.031	
A1	0.500	0.700	0.020	0.028	
b	0.250	0.350	0.010	0.014	
С	0.080	0.150	0.003	0.006	
D	0.750	0.850	0.030	0.033	
E	1.100	1.300	0.043	0.051	
E1	1.500	1.700	0.059	0.067	
E2	0.200 REF		0.008	REF	
L	0.010	0.070	0.001	0.003	
θ	7° RFF		7° F	RFF	

Suggested Pad Layout



Note:

- 1.Controlling dimension:in millimeters.
- 2.General tolerance:± 0.05mm.
- 3. The pad layout is for reference purposes only.

REEL SPECIFICATION

P/N	PKG	QTY
BAT46X	SOD-523	3000





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